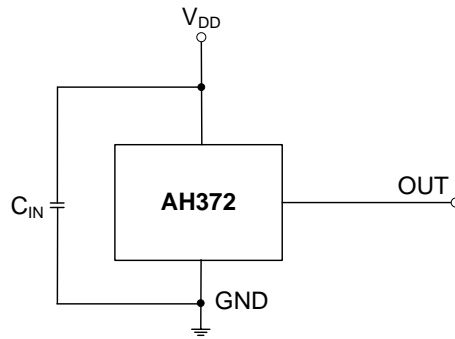


Typical Application Circuits (cont.)



Typical AH372 Circuit

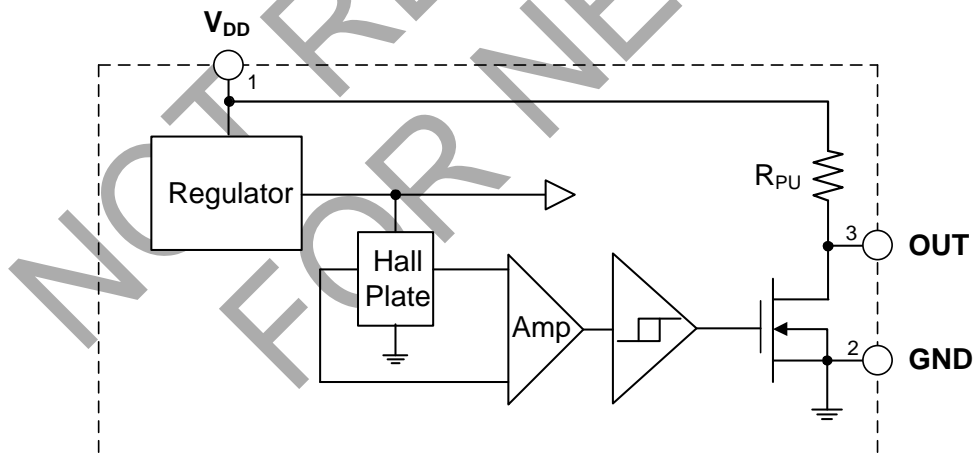
Note: 4. C_{IN} is for power stabilization and to strengthen the noise immunity, the recommended capacitance is 100nF typical.

Pin Descriptions

Packages: SC59, SOT23, SIP-3 (Ammo Pack) and SIP-3 (Bulk Pack)

Pin Number	Pin Name	Function
1	V_{DD}	Power Supply Input
2	GND	Ground
3	OUT	Output

Functional Block Diagram



Absolute Maximum Ratings (Note 5) @ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Symbol	Characteristics	Values	Unit
V_{DD}	Supply Voltage (Note 6)	28	V
$V_{OUT (OFF)}$	Output "Off" Voltage	28	V
$I_O (SINK)$	Output "On" Current (Sink)	25	mA
B	Magnetic Flux Density	Unlimited	
P_D	Package Power Dissipation	SIP-3 (Ammo Pack) and SIP-3 (Bulk Pack)	550 mW
		SC59 and SOT23	230 mW
T_{STG}	Storage Temperature Range	-65 to +150	$^\circ\text{C}$
T_J	Maximum Junction Temperature	+150	$^\circ\text{C}$

Notes:

- Stresses greater than the 'Absolute Maximum Ratings' specified above can cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability can be affected by exposure to absolute maximum rating conditions for extended periods of time.
- The absolute maximum V_{DD} of 28V is a transient stress rating and is not meant as a functional operating condition. It is not recommended to operate the device at the absolute maximum rated conditions for any period of time.

Recommended Operating Conditions (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Symbol	Characteristic	Conditions	Rating	Unit
V_{DD}	Supply Voltage (Note 7)	Operating	2.2 to 20	V
T_A	Operating Temperature Range	Operating	-40 to +125	$^\circ\text{C}$

Note: 7. The output of IC will be switched after the supply voltage is over 2.2V, but the magnetic characteristics will not be normal until the supply is over 2.5V.

Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, $V_{DD} = 12\text{V}$, unless otherwise specified.)

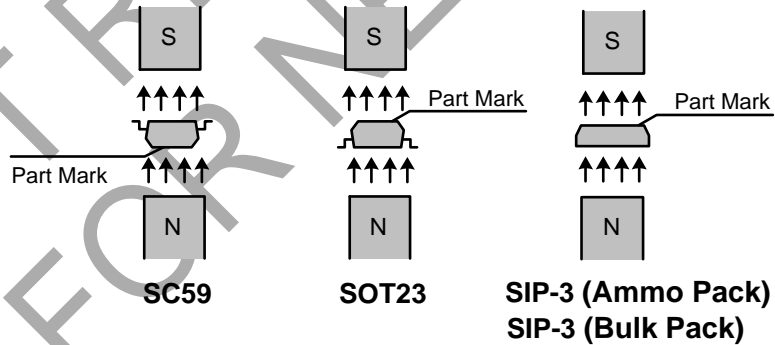
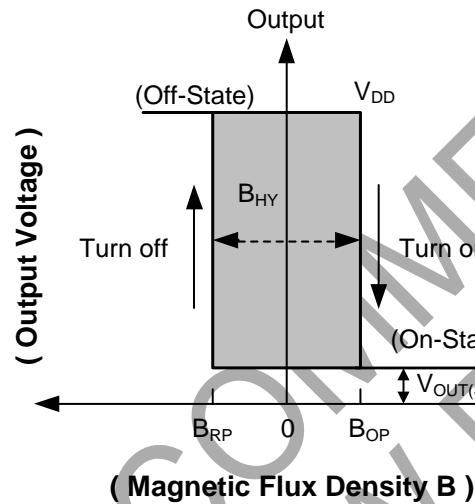
Symbol	Characteristic	Conditions	Min	Typ	Max	Unit
V_{OUT}	Output On Voltage	$I_{OUT} = 20\text{mA}$	—	300	400	mV
I_{DD}	Supply Current	$B < B_{RP}$	—	2	4	mA
I_{OFF}	Output Leakage Current	Output off	—	< 0.1	10	μA
R_{PU}	Internal Pull-up Resistor	—	7	10	13	$\text{k}\Omega$

Magnetic Characteristics (Note 8) (@ $T_A = +25^\circ\text{C}$, $V_{DD} = 2.5\text{V}$ to 20V , unless otherwise specified.)

(1mT=10 Gauss)

Symbol	Characteristic	Min	Typ	Max	Unit
B_{OP} (South Pole to Part Marking Side for SIP-3 (Ammo Pack), SIP-3 (Bulk Pack) and SOT23; North Pole to Part Marking Side for SC59)	Operation Point	5	30	60	Gauss
B_{RP} (South Pole to Part Marking Side for SIP-3 (Ammo Pack), SIP-3 (Bulk Pack) and SOT23; North Pole to Part Marking Side for SC59)	Release Point	-60	-30	-5	
B_{HY} ($ B_{OPX} - B_{RPX} $)	Hysteresis	—	60	—	

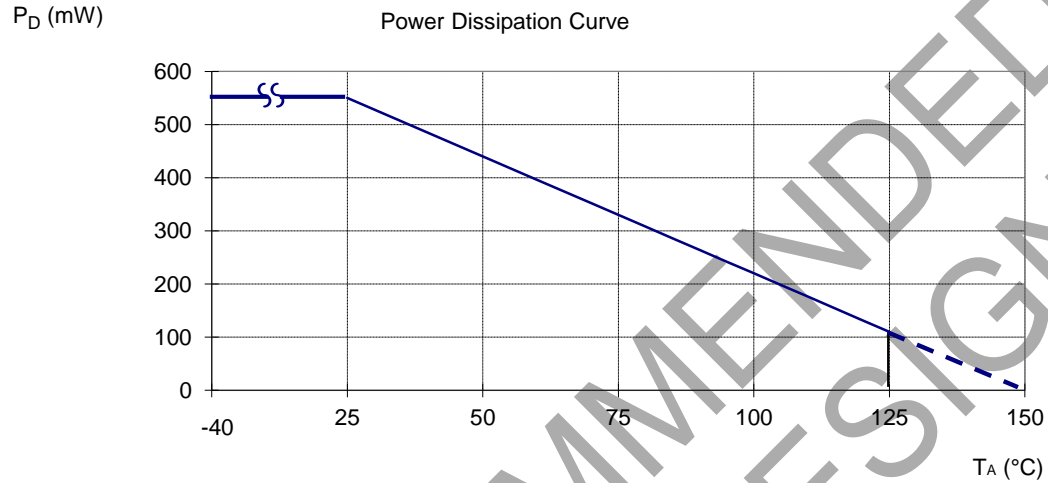
Note: 8. The magnetic characteristics may vary with supply voltage, operating temperature and after soldering.



Thermal Performance Characteristics

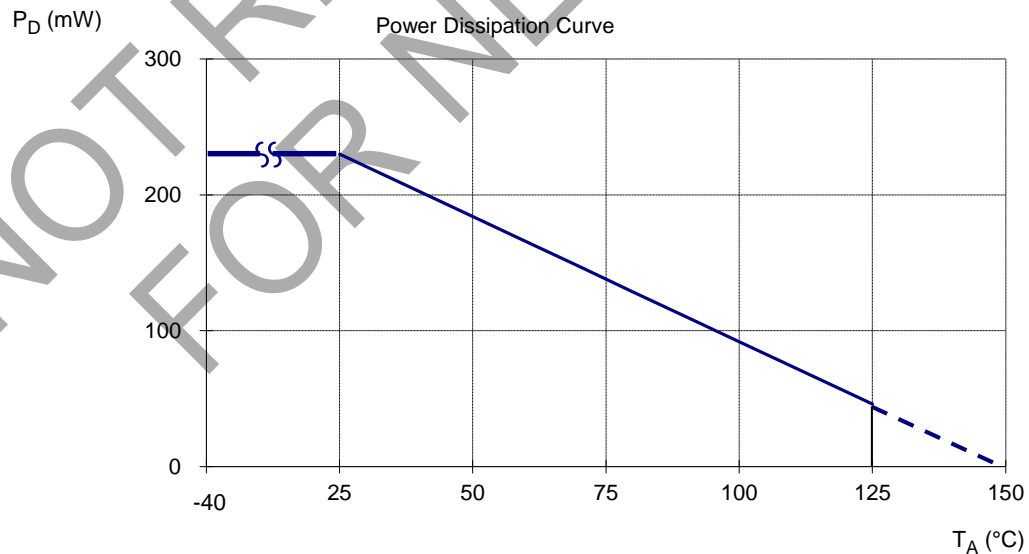
(1) Package Types: SIP-3 (Ammo Pack) and SIP-3 (Bulk Pack)

T _A (°C)	25	50	60	70	80	85	90	95	100	105	110	115	120	125	130	135	140	150
P _D (mW)	550	440	396	352	308	286	264	242	220	198	176	154	132	110	88	66	44	0

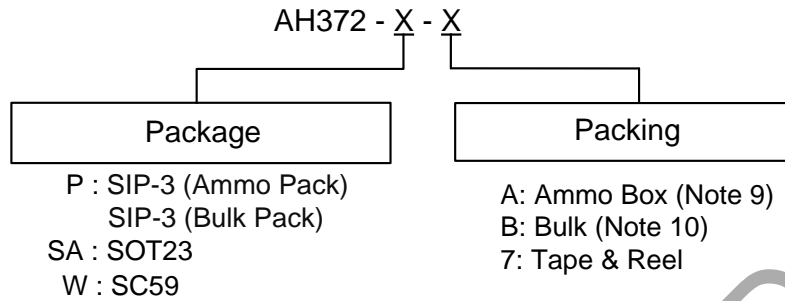


(2) Package Types: SC59 and SOT23

T _A (°C)	25	50	60	70	80	85	90	100	110	120	130	140	150
P _D (mW)	230	184	166	147	129	120	110	92	74	55	37	18	0



Ordering Information



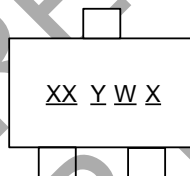
Part Number	Package Code	Packaging (Note 11)	Bulk		7" Tape and Reel		Ammo Box	
			Quantity	Part Number Suffix	Quantity	Part Number Suffix	Quantity	Part Number Suffix
AH372-P-A	P	SIP-3 (Ammo Pack)	NA	NA	NA	NA	4000/Box	-A
AH372-P-B	P	SIP-3 (Bulk Pack)	1000	-B	NA	NA	NA	NA
AH372-SA-7	SA	SOT23	NA	NA	3000/Tape & Reel	-7	NA	NA
AH372-W-7	W	SC59	NA	NA	3000/Tape & Reel	-7	NA	NA

Notes: 9. Ammo Box is for SIP-3 (Ammo Pack) Spread Lead.
 10. Bulk is for SIP-3 (Bulk Pack) Straight Lead.
 11. Reverse taping as shown on Diodes Incorporated's Surface Mount (SMD) Packaging document AP02007, which can be found on our website <https://www.diodes.com/assets/Packaging-Support-Docs/ap02007.pdf>.

Marking Information

(1) Package Types: SC59 and SOT23

(Top View)

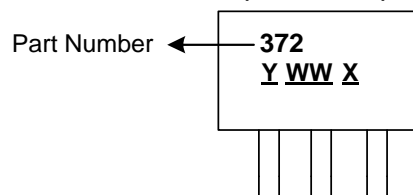


XX : Identification Code
 Y : Year 0 to 9
 W : Week : A to Z : 1 to 26 Week;
 a to z : 27 to 52 Week; z Represents
 52 and 53 Week
 X : Internal Code

Part Number	Package	Identification Code
AH372	SC59	XH
AH372	SOT23	YH

(2) Package Types: SIP-3 (Ammo Pack) and SIP-3 (Bulk Pack)

(Front View)

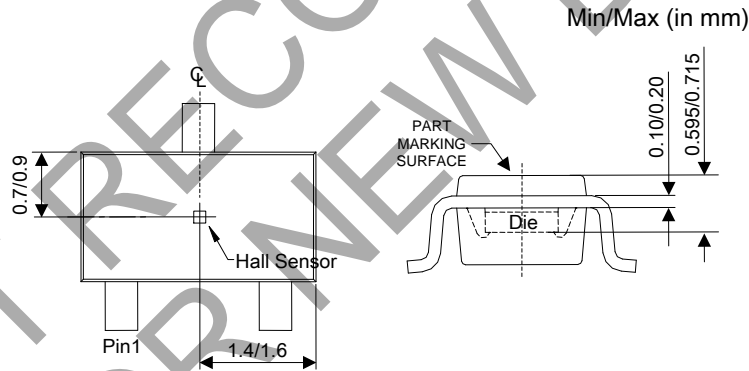
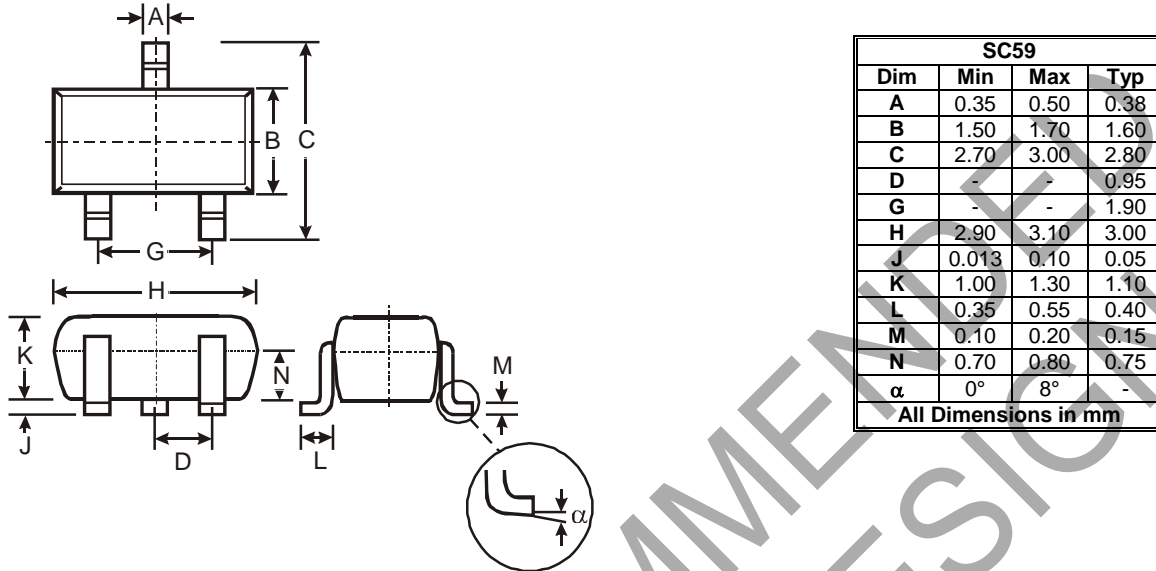


Y : Year : 0~9
 WW : Week : 01~52, "52" Represents
 52 and 53 Week
 X : Internal Code

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

(1) Package Type: SC59

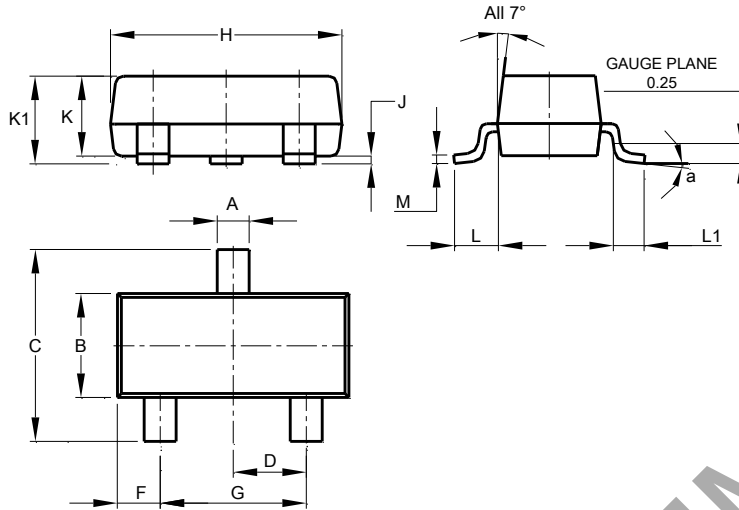


Sensor Location

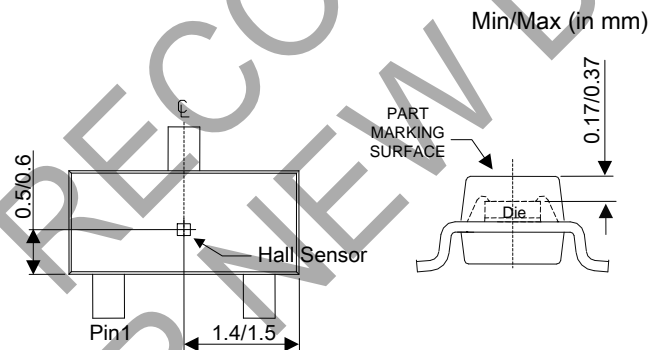
Package Outline Dimensions (cont.)

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

(2) Package Type: SOT23



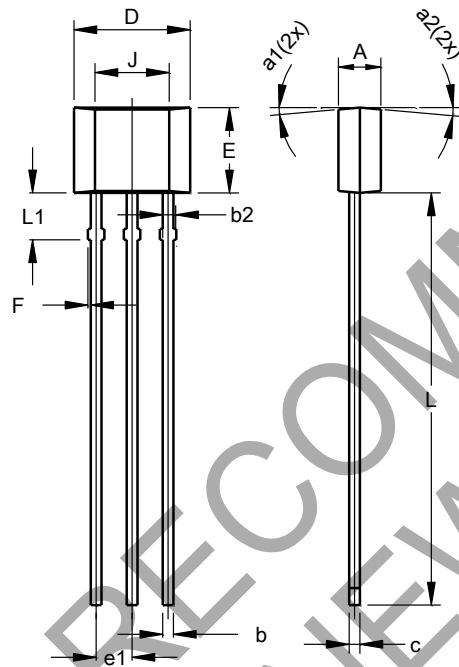
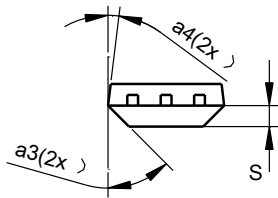
SOT23			
Dim	Min	Max	Typ
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.890	1.00	0.975
K1	0.903	1.10	1.025
L	0.45	0.61	0.55
L1	0.25	0.55	0.40
M	0.085	0.150	0.110
a	0°	8°	--
All Dimensions in mm			



Sensor Location

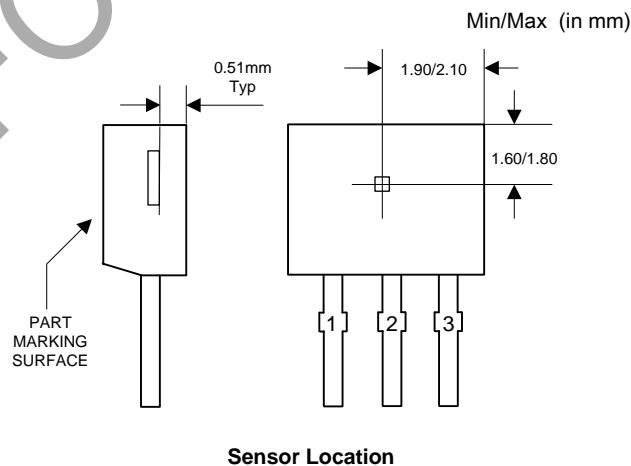
Package Outline Dimensions (cont.)

 Please see <http://www.diodes.com/package-outlines.html> for the latest version.

(3) Package Type: SIP-3 (Bulk Pack)


SIP-3 (Bulk Pack)			
Dim	Min	Max	Typ
A	1.40	1.60	1.50
b	0.33	0.43	0.38
b2	0.40	0.508	0.46
c	0.35	0.41	0.38
D	3.90	4.30	4.10
E	2.80	3.20	3.00
e1	1.24	1.30	1.27
F	0.00	0.20	--
J	2.62 REF		
L	14.00	15.00	14.50
L1	1.55	1.75	1.65
S	0.63	0.84	0.74
a1	--	--	5°
a2	--	--	5°
a3	--	--	45°
a4	--	--	3°
All Dimensions in mm			

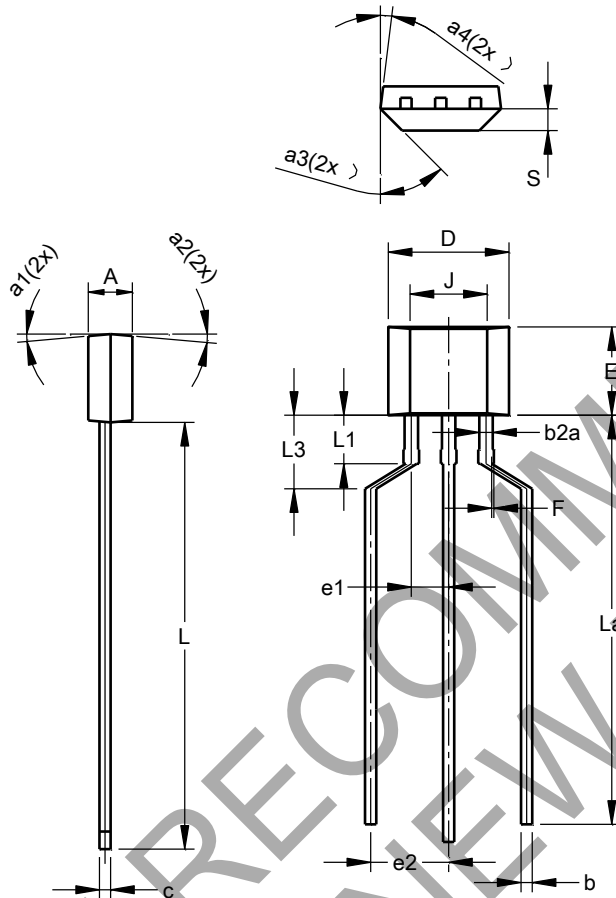
Note: 12. SIP-3 (Bulk Pack) - Thickness J includes Burrs



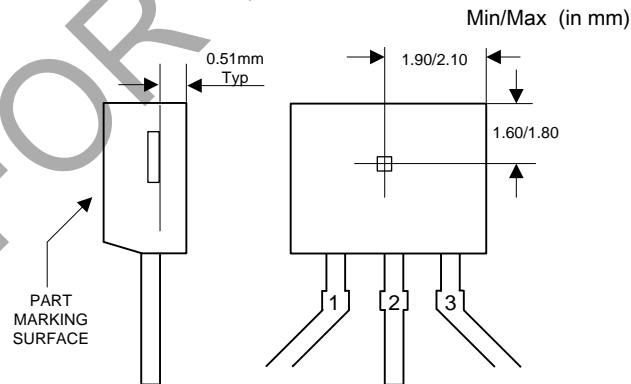
Package Outline Dimensions (cont.)

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

(4) Package Type: SIP-3 (Ammo Pack)



SIP-3 (Ammo Pack)			
Dim	Min	Max	Typ
A	1.40	1.60	1.50
b	0.33	0.43	0.38
b2a	0.40	0.52	0.46
c	0.35	0.41	0.38
D	3.90	4.30	4.10
E	2.80	3.20	3.00
e1	1.24	1.30	1.27
e2	2.40	2.90	2.65
F	0.00	0.20	--
J	2.62 REF		
L	14.00	15.00	14.50
La	12.90	14.90	13.90
L1	1.55	1.75	1.65
L3	2.00	3.00	2.50
S	0.63	0.84	0.74
a1	--	--	5°
a2	--	--	5°
a3	--	--	45°
a4	--	--	3°
All Dimensions in mm			

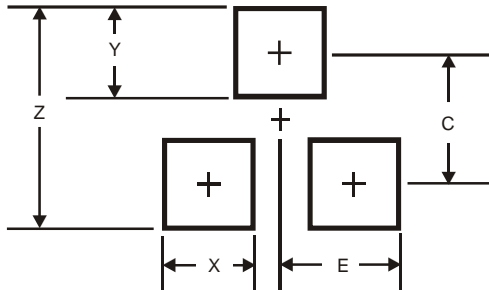


Sensor Location

Suggested Pad Layout

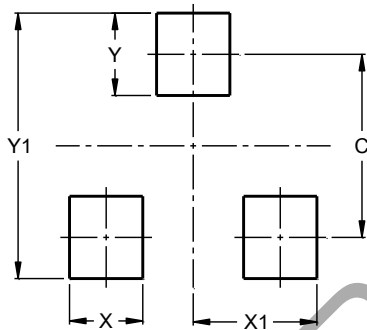
Please see <http://www.diodes.com/package-outlines.html> for the latest version.

(1) Package Type: SC59



Dimensions	Value (in mm)
Z	3.4
X	0.8
Y	1.0
C	2.4
E	1.35

(2) Package Type: SOT23



Dimensions	Value (in mm)
C	2.0
X	0.8
X1	1.35
Y	0.9
Y1	2.9

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